

NOT RECOMMENDED FOR NEW DESIGN CONTACT US



DMTH4001SPSQ

40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
40V	$1.0 \text{m}\Omega$ @ V _{GS} = 10V	225A

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low Rds(ON) Minimizes On State Losses
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH4001SPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

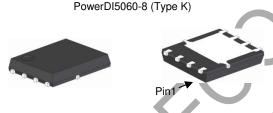
Description and Applications

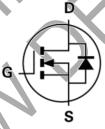
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

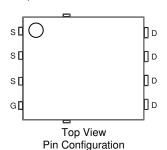
- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)







Bottom View Internal Schematic

Ordering Information (Note 4)

Top View

Part Number	Packago	Packing		
Part Number	Package	Qty.	Carrier	
DMTH4001SPSQ-13	PowerDI5060-8 (Type K)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



TH4001SS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 21 = 2021)
 WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	40	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current, VGS = 10V (Note 6)	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	lD	225 160	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	900	Α	
Continuous Body Diode Forward Current (Note 6) T _C = +25°C		Is	200	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	Ism	900	Α	
Avalanche Current, L = 0.1mH	las	93.8	Α	
Avalanche Energy, L = 0.1mH	Eas	440	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	3.1	W
Thermal Resistance, Junction to Ambient (Note 5)		RθJA	48	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	Pp	187.5	W
Thermal Resistance, Junction to Case (Note 6)		R _e JC	8.0	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

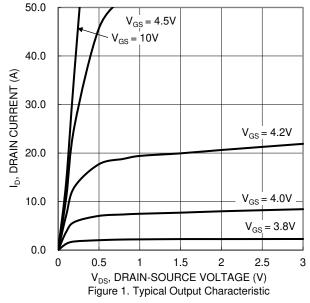
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	40		1-	V	VGS = 0V, ID = 1mA	
Zero Gate Voltage Drain Current	IDSS	_		1	μΑ	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	Igss	/	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	2	2.61	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	0.73	1.0	mΩ	$V_{GS} = 10V, I_{D} = 30A$	
Diode Forward Voltage	V_{SD}		0.7	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		10787			V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		3929	1	pF		
Reverse Transfer Capacitance	Crss		156			1 = 1101112	
Gate Resistance	Rg	_	3.71	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	144	_		$V_{DD} = 20V$, $I_D = 50A$, $V_{GS} = 10V$	
Gate-Source Charge	Qgs	_	40	_	nC		
Gate-Drain Charge	Qgd	_	24	_			
Turn-On Delay Time	td(ON)	_	11	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 50A, R_{g} = 2.5\Omega$	
Turn-On Rise Time	t _R	_	44	_			
Turn-Off Delay Time	tD(OFF)	_	85	_	ns		
Turn-Off Fall Time	tF	_	38				
Reverse Recovery Time	trr		68		ns	In - 15A di/dt - 100A/us	
Reverse Recovery Charge	QRR	_	110	_	nC	-IF = 15A, di/dt = 100A/μs	

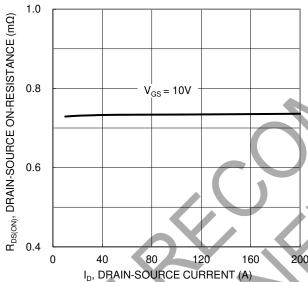
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

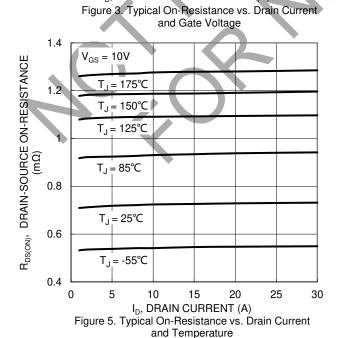
 ^{5.} Device involved on the state it of board, 200 copper, with themal bias to
 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to product testing.

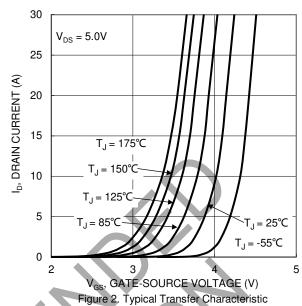


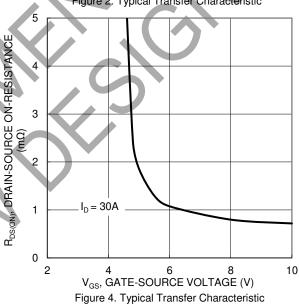












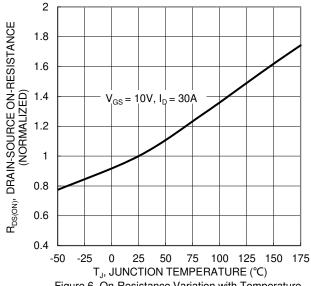


Figure 6. On-Resistance Variation with Temperature





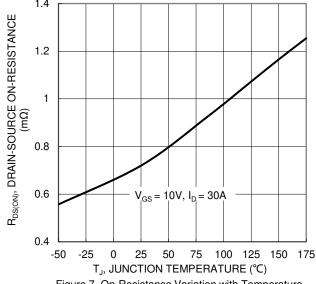


Figure 7. On-Resistance Variation with Temperature

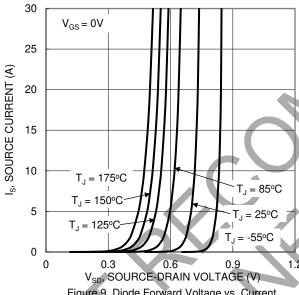
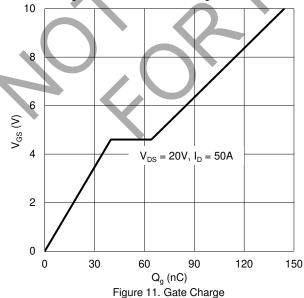
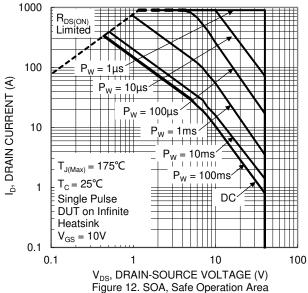


Figure 9. Diode Forward Voltage vs. Current

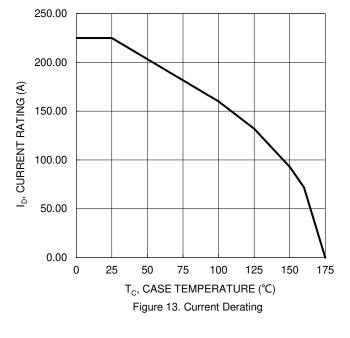


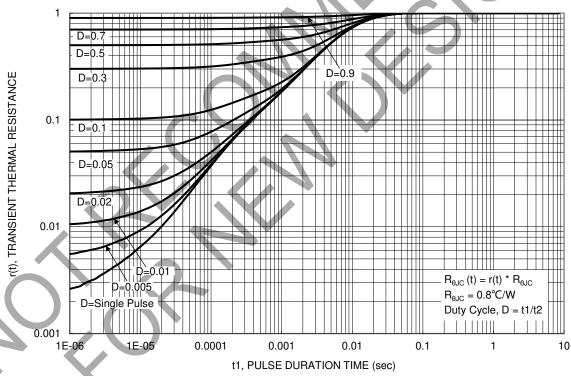
4 $V_{GS(TH)}, \text{ GATE THRESHOLD VOLTAGE }(V)$ 3.5 3 $I_D = 1mA$ 2.5 2 $I_D = 250 \mu A$ 1.5 1 0.5 0 0 25 50 75 100 125 T_J, JUNCTION TEMPERATURE (°C) 100 125 150 175 -50 Figure 8. Gate Threshold Variation vs. Junction

Temperature 100000 f = 1MHz10000 , JUNCTION CAPACITANCE Coss 1000 100 10 20 25 0 15 30 35 40 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 10. Typical Junction Capacitance







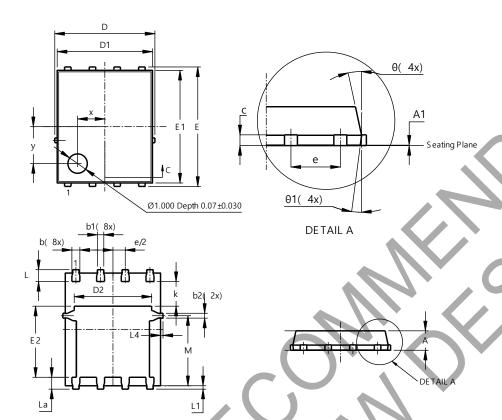




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)

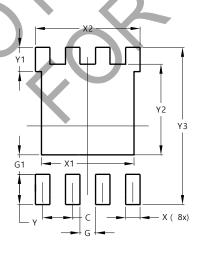


PowerDI5060-8 (Type K)						
Dim						
Α	0.90	1.10	1.00			
A1	0	0.05	0.02			
b	0.33	0.51	0.41			
b1	0.300	0.366	0.333			
b2	0.20	0.35	0.25			
C	0.23	0.33	0.277			
D	5	.15 BS0)			
D1	4.85	4.95	4.90			
D2		1	3.98			
E	6	.15 BS0)			
E1	5.75	5.85	5.80			
E2	3.56	3.725	3.66			
е	1	.27BSC				
k		-	1.27			
۲	0.51	0.71	0.61			
La	0.51	0.675	0.61			
L1	0.05	0.20	0.175			
L4	-	-	0.125			
M	3.50	3.71	3.605			
X	-	-	1.400			
у	-	-	1.900			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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